

IMPROVED INTEGRATED CHIP PACKAGE
 HAVING INTERMEDIATE SUBSTRATE
 SEHAT SUTARDJA
 MP0115
 SHEET 1/3

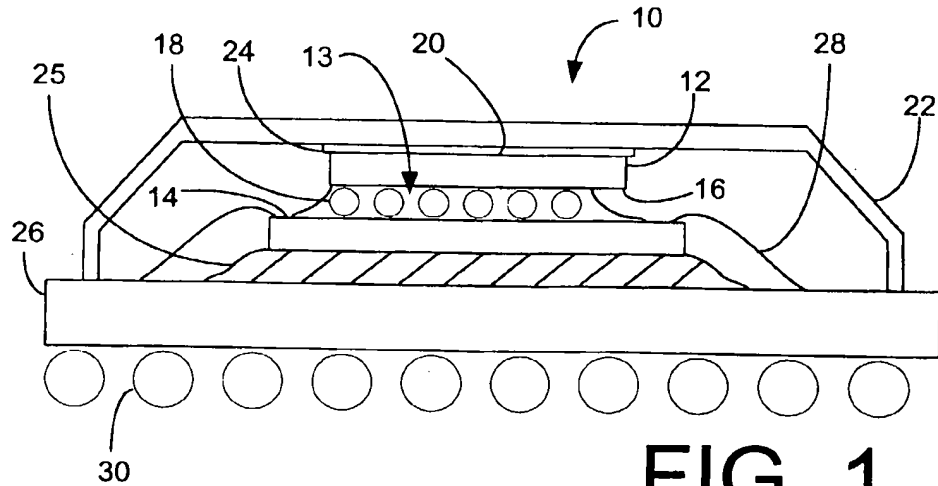


FIG. 1

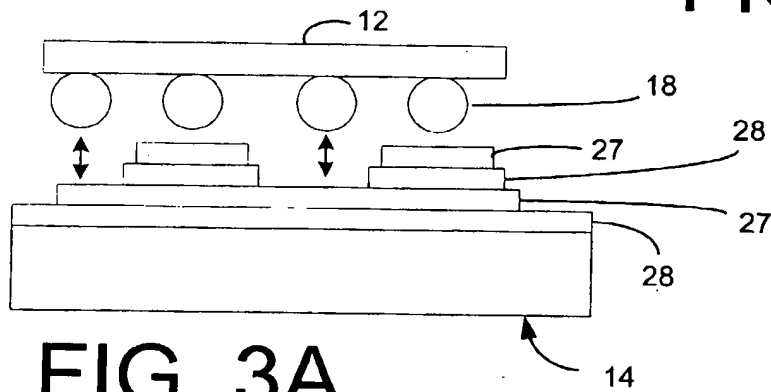


FIG. 3A

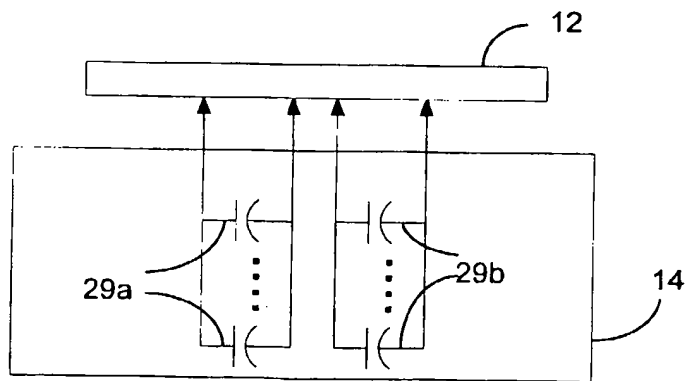


FIG. 3B

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